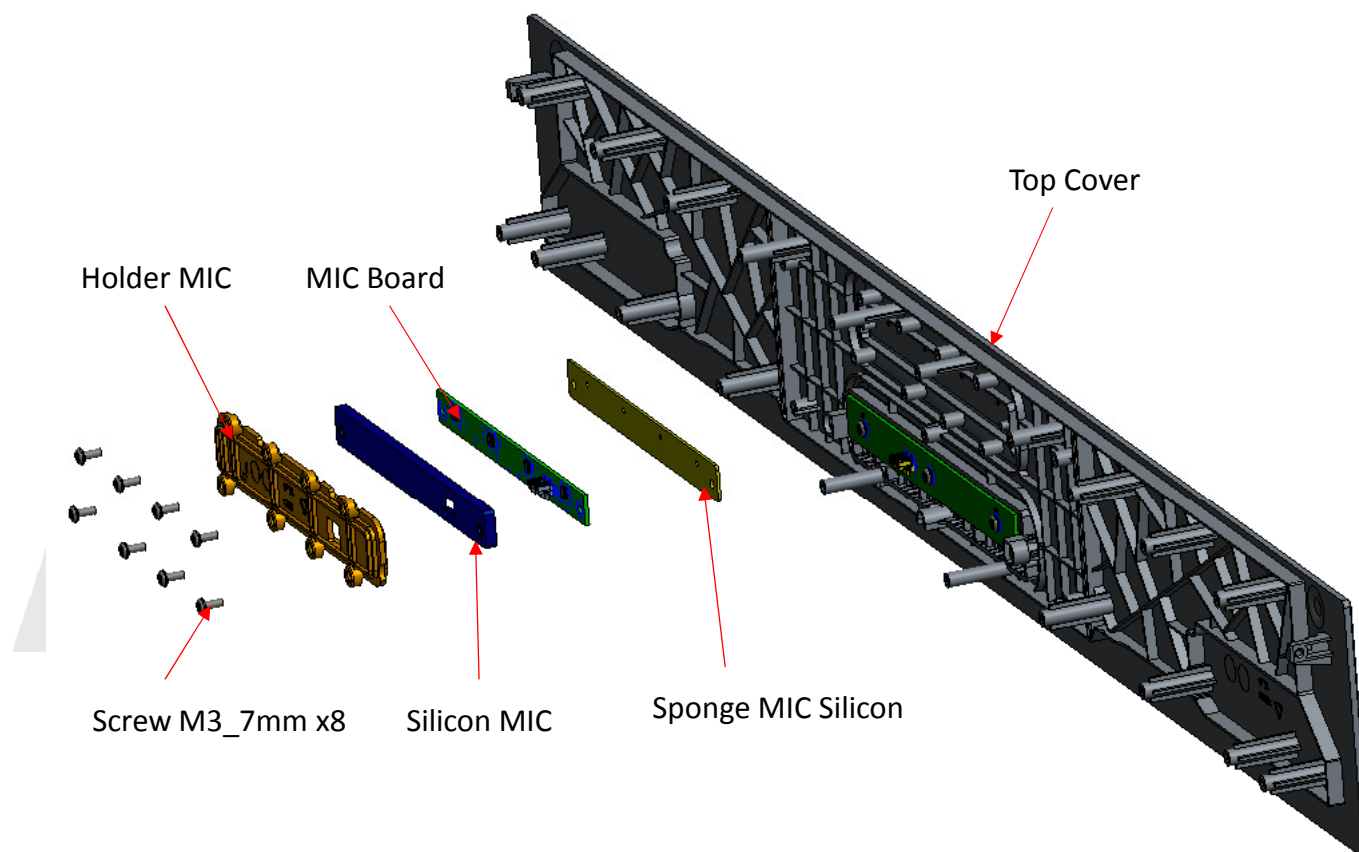


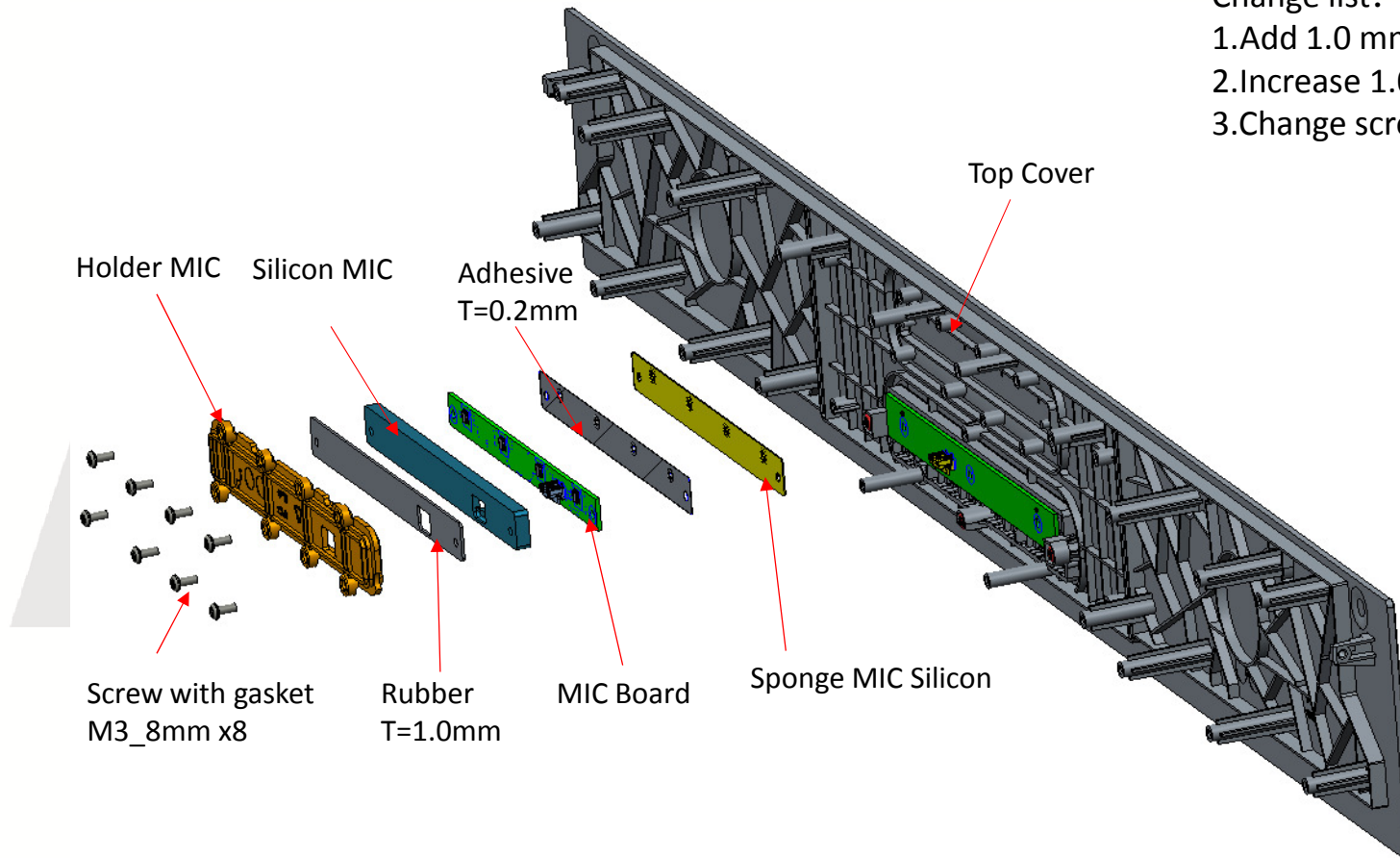
Current MIC board assembly



Modified MIC test

Change list:

- 1.Add 1.0 mm thickness adhesive on PONGE_MIC_SILICON
- 2.Increase 1.0mm thickness in SILICON_MIC
- 3.Change screw M3*7 to M3*8(with gasket)

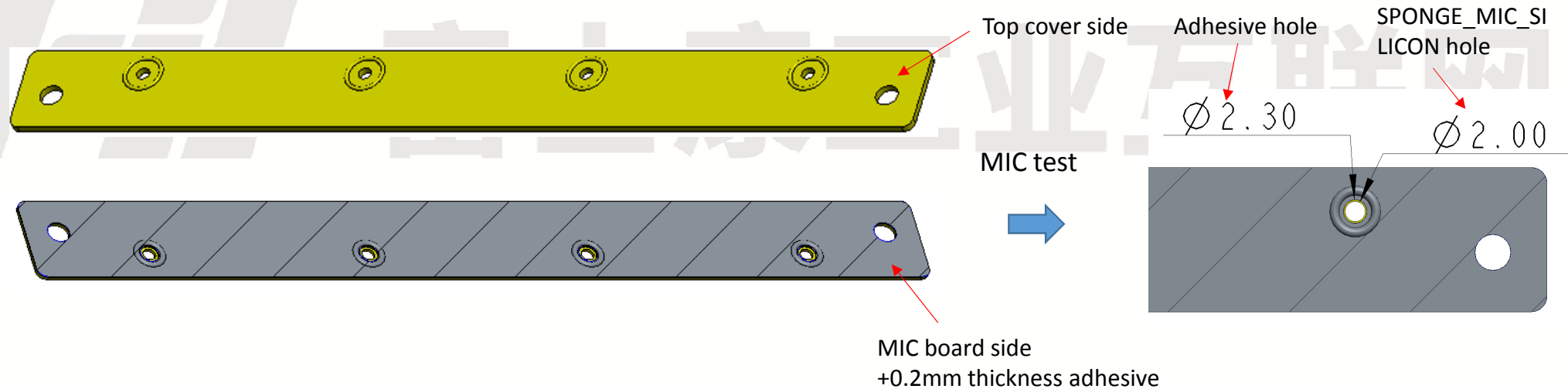


SPONGE_MIC_SILICON

Current sample



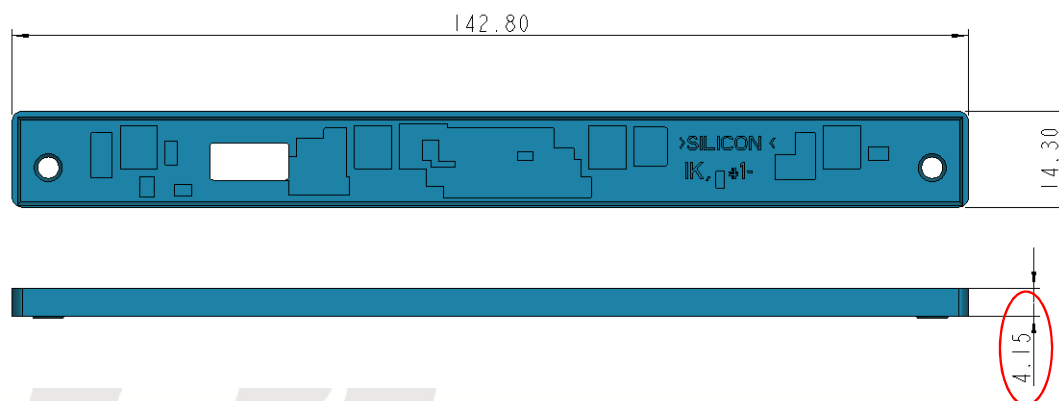
Modified sample



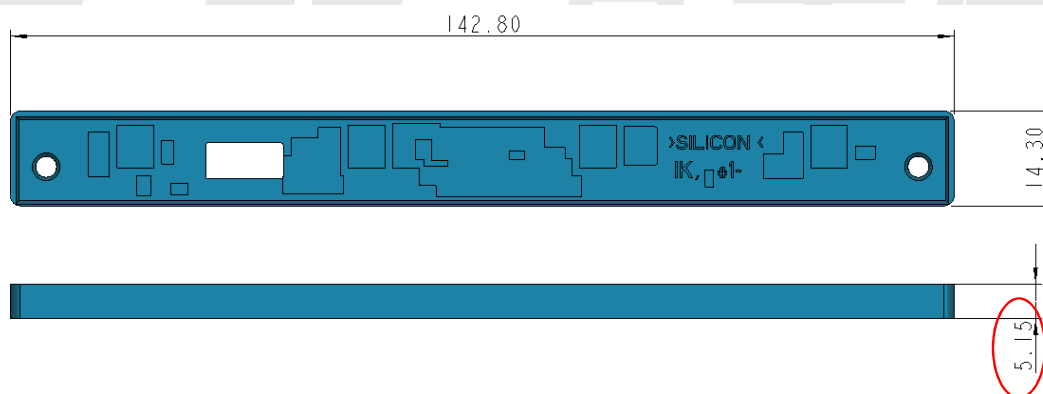
Add 0.2mm thickness adhesive on the MIC board side

SILICON_MIC

Current sample

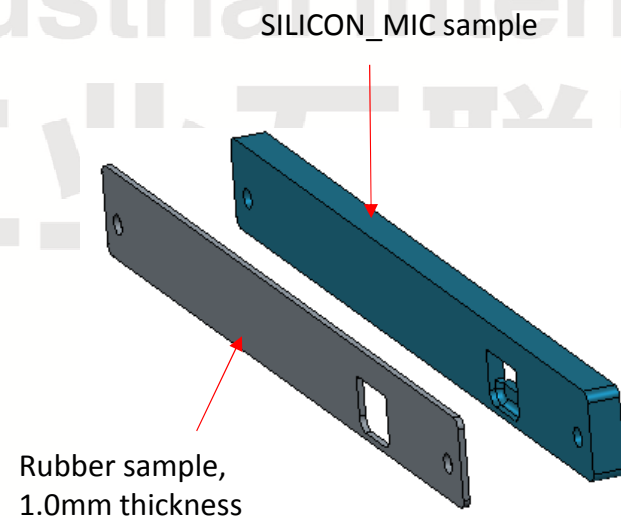


Suggest to modify in next build



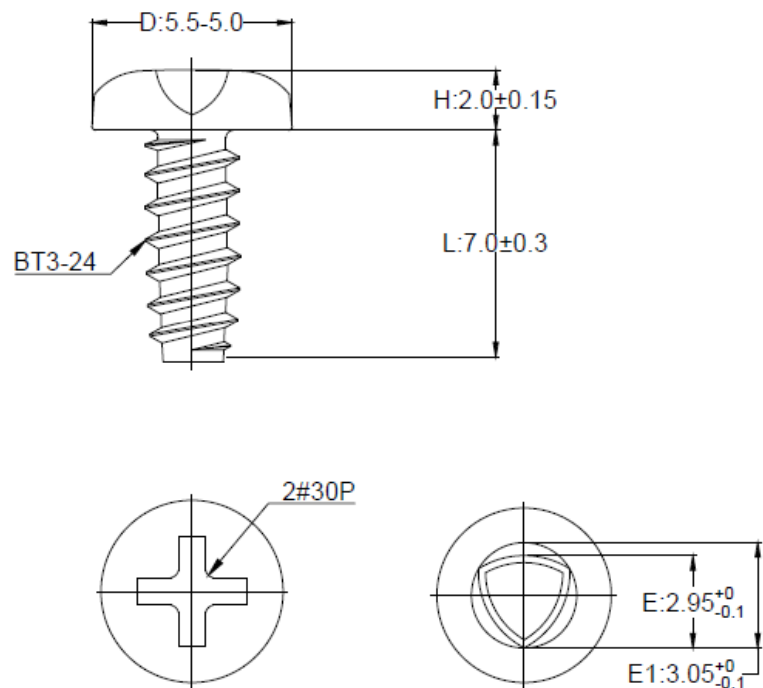
Increase 1.0mm thickness in SILICON_MIC

MIC test

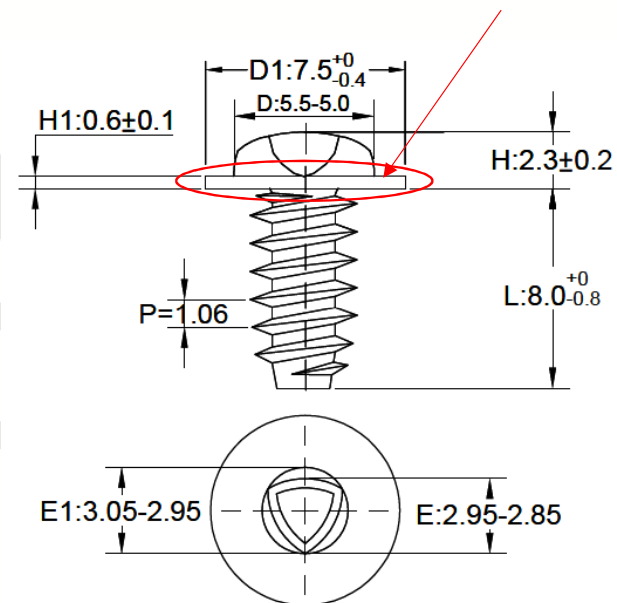


SCREW

Current screw



Modified screw



Screw with gasket